5-146278-8 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 5-146278-8 PCB Mount Header, Vertical, Board-to-Board, 8 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 8

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	8
Number of Rows	1
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Operating Voltage	30 VAC
Body Features	
Connector Profile	Standard
Primary Product Color	Black
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]

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	100 – 200 µin
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.05 mm[.12 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Compatible With Approved Standards Products	CSA LR7189, UL E28476

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UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Quantity	200			
Packaging Method	Carton			
Product Compliance For compliance documentation, visit the product page on TE.com>				
EU RoHS Directive 2011/65/EU	Compliant			
EU ELV Directive 2000/53/EC	Compliant			
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold			
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC			
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free			
Solder Process Capability	Pin-in-Paste capable to 260°C			

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



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Also in the Series AMPMODU Headers



Customers Also Bought



TE Part #2-5767004-2	TE Part #350712-1	TE Part #2106136-2	TE Part #350786-1
MICTOR RECEPT ASSY, 38 POS.	09P UMNL PIN HDR ASSY 94VO	Assembly, Receptacle, 2-Position	02P UMNL HDR ASSY 94VO



Documents

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_5-146278-8_E.2d_dxf.zip

English

Customer View Model

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ENG_CVM_CVM_5-146278-8_E.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_5-146278-8_E.3d_stp.zip

English

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